# 68030/040 PECL to TTL **Clock Driver**

The MC10H/100H644 generates the necessary clocks for the 68030, 68040 and similar microprocessors. The device is functionally equivalent to the H640, but with fewer outputs in a smaller outline 20-lead PLCC package. It is guaranteed to meet the clock specifications required by the 68030 and 68040 in terms of part-to-part skew, within-part skew and also duty cycle skew.

The user has a choice of using either TTL or PECL (ECL referenced to +5.0 V) for the input clock. TTL clocks are typically used in present MPU systems. However, as clock speeds increase to 50 MHz and beyond, the inherent superiority of ECL (particularly differential ECL) as a means of clock signal distribution becomes increasingly evident. The H644 also uses differential ECL internally to achieve its superior skew characteristic.

The H644 includes divide-by-two and divide-by-four stages, both to achieve the necessary duty cycle and skew to generate MPU clocks as required. A typical 50 MHz processor application would use an input clock running at 100 MHz, thus obtaining output clocks at 50 MHz and 25 MHz (see Logic Symbol).

W SOURCE STREET The 10H version is compatible with MECL<sup>™</sup> 10H ECL logic levels, while the 100H version is compatible with 100K levels (referenced to +5.0 V).

- Generates Clocks for 68030/040
- Meets 68030/040 Skew Requirements
- TTL or PECL Input Clock
- Extra TTL and ECL Power/Ground Pins
- Within Device Skew on Similar Paths is 0.5 ns
- Asynchronous Reset
- Single +5.0 V Supply

#### Function

Reset (R): LOW on RESET forces all Q outputs LOW and all  $\overline{Q}$ outputs HIGH.

Synchronized Outputs: The device is designed to have the POS edges of the  $\div 2$  and  $\div 4$  outputs synchronized.

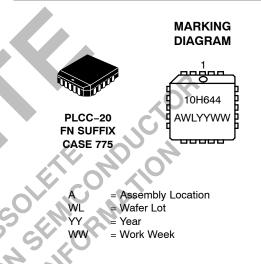
Select (SEL): LOW selects the PECL input source (DE/DE). HIGH selects the TTL input source (DT).

The H644 also contains circuitry to force a stable state of the PECL input differential pair, should both sides be left open. In this case, the DE side of the input is pulled LOW, and  $\overline{DE}$  goes HIGH.



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#### **ORDERING INFORMATION**

Device	Package Shipping			
MC10H644FN	PLCC-20	37 Units/Rail		
MC100H644FN	PLCC-20	37 Units/Rail		

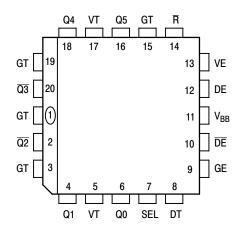
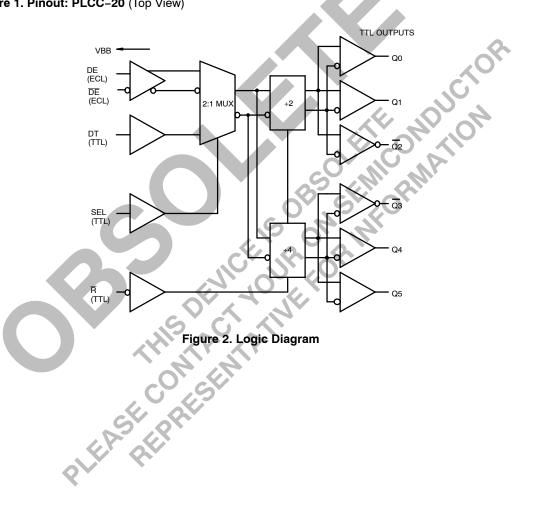


Figure 1. Pinout: PLCC-20 (Top View)

#### Table 1. PIN DESCRIPTION

PIN	FUNCTION
GT VT VE GE DE, DE V <sub>BB</sub> DT Qn, Qn SEL R	$\begin{array}{l} \mbox{TTL Ground (0 V)} \\ \mbox{TTL V}_{CC} (+5.0 V) \\ \mbox{ECL V}_{CC} (+5.0 V) \\ \mbox{ECL Ground (0 V)} \\ \mbox{ECL Signal Input (positive ECL)} \\ \mbox{V}_{BB} \mbox{Reference Output} \\ \mbox{TTL Signal Input} \\ \mbox{Signal Outputs (TTL)} \\ \mbox{Input Select (TTL)} \\ \mbox{Reset (TTL)} \end{array}$

\*Skews are specified for Identical Edges



#### Table 2. 10H PECL DC CHARACTERISTICS ( $V_T = V_E = 5.0 \text{ V} \pm 5\%$ )

			0°	0°C		25°C		85°C	
Symbol	Characteristic	Condition	Min	Max	Min	Max	Min	Max	Unit
I <sub>INH</sub> I <sub>INL</sub>	Input HIGH Current Input LOW Current		0.5	255	0.5	175	0.5	175	μΑ
V <sub>IH</sub> * V <sub>IL</sub> *	Input HIGH Voltage Input LOW Voltage	V <sub>E</sub> = 5.0 V	3.83 3.05	4.16 3.52	3.87 3.05	4.19 3.52	3.94 3.05	4.28 3.55	V
V <sub>BB</sub> *	Output Reference Voltage	V <sub>E</sub> = 5.0 V	3.62	3.73	3.65	3.75	3.69	3.81	V

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

#### Table 3. 100H PECL DC CHARACTERISTICS ( $V_T = V_E = 5.0 \text{ V} \pm 5\%$ )

			0°C		25°C		85°C		
Symbol	Characteristic	Condition	Min	Max	Min	Max	Min	Max	Unit
I <sub>INH</sub> I <sub>INL</sub>	Input HIGH Current Input LOW Current		0.5	255	0.5	175	0.5	175	μA
V <sub>IH</sub> * V <sub>IL</sub> *	Input HIGH Voltage Input LOW Voltage	V <sub>E</sub> = 5.0 V	3.835 3.19	4.12 3.525	3.835 3.19	4.12 3.525	3.835 3.19	4.12 3.525	V
V <sub>BB</sub> *	Output Reference Voltage	V <sub>E</sub> = 5.0 V	3.62	3.74	3.62	3.74	3.62	3.74	V

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

\*PECL levels are referenced to  $V_{CC}$  and will vary 1:1 with the power supply. The values shown are for  $V_{CC}$  = 5.0 V.

Only corresponds to ECL Clock Inputs.

## Table 4. DC CHARACTERISTICS (VT = VE = $5.0 \text{ V} \pm 5\%$ )

				<b>0</b> °	0°C 25°		25°C 85°C		°C	
Symbol	Characteristic		Condition	Min	Мах	Min	Max	Min	Max	Unit
I <sub>EE</sub>	Power Supply Current	ECL	V <sub>E</sub> Pin	<	65		65		65	mA
I <sub>CC</sub>		TTL	Total all V <sub>T</sub> pins		85		85		85	mA

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

### Table 5. TTL DC CHARACTERISTICS ( $V_T = V_E = 5.0 \text{ V} \pm 5\%$ )

			0°C		25°C		85°C			
Symbol	Characteristic	Condition	Min	Max	Min	Max	Min	Max	Unit	
V <sub>IH</sub> V <sub>IL</sub>	Input HIGH Voltage Input LOW Voltage		2.0	0.8	2.0	0.8	2.0	0.8	V	
IIH	Input HIGH Current	V <sub>IN</sub> = 2.7 V V <sub>IN</sub> = 7.0 V		20 100		20 100		20 100	μA	
IIL	Input LOW Current	V <sub>IN</sub> = 0.5 V		-0.6		-0.6		-0.6	mA	
V <sub>OH</sub>	Output HIGH Voltage	I <sub>OH</sub> = –3.0 mA I <sub>OH</sub> = –24 mA	2.5 2.0		2.5 2.0		2.5 2.0		V	
V <sub>OL</sub>	Output LOW Voltage	I <sub>OL</sub> = 24 mA		0.5		0.5		0.5	V	
V <sub>IK</sub>	Input Clamp Voltage	I <sub>IN</sub> = -18 mA		-1.2		-1.2		-1.2	V	
I <sub>OS</sub>	Output Short Circuit Current	V <sub>OUT</sub> = 0 V	-100	-225	-100	-225	-100	-225	mA	

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

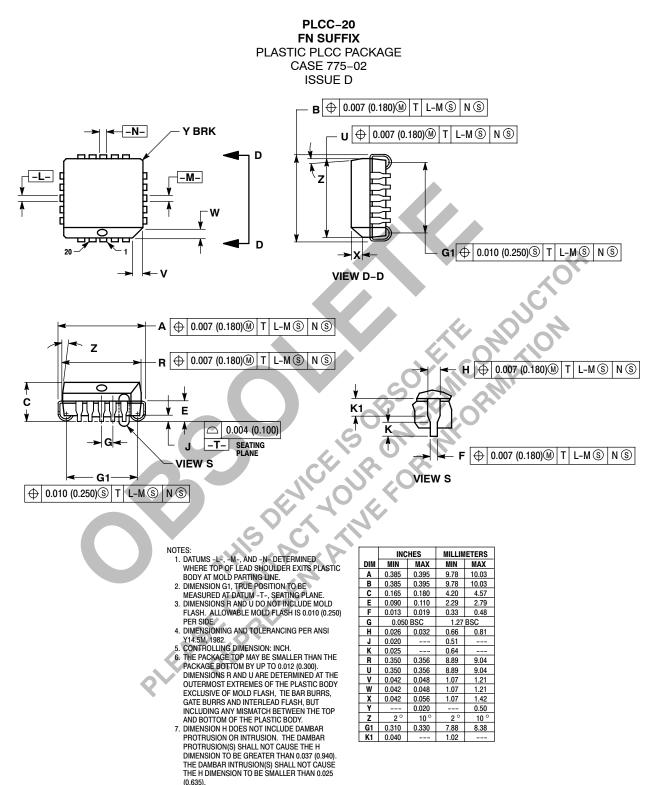
				<b>0</b> °	C	25	°C	85°C			
Symbol	Characteristic		Condition	Min	Max	Min	Max	Min	Max	Unit	
t <sub>PLH</sub>	Propagation Delay ECL D to Output	All Outputs	CL = 50 pF	5.8	6.8	5.7	6.7	6.1	7.1	ns	
t <sub>PLH</sub>	Propagation Delay TTL D to Output		CL = 50 pF	5.7	6.7	5.7	6.7	6.0	7.0	ns	
t <sub>skwd</sub> *	Within-Device Skew	Q0, 1, 4, 5	CL = 50 pF	-	0.5	-	0.5	-	0.5	ns	
t <sub>skwd</sub> *	Within-Device Skew	<u>Q2</u> , <u>Q3</u>	CL = 50 pF	-	0.5	-	0.5	-	0.5	ns	
t <sub>skwd</sub> *	Within-Device Skew	All Outputs	CL = 50 pF	-	1.5	-	1.5	-	1.5	ns	
t <sub>skp-p</sub> *	Part-to-Part Skew	Q0, 1, 4, 5	CL = 50 pF	-	1.0	-	1.0	-	1.0	ns	
t <sub>PD</sub>	Propagation Delay R to Output	All Outputs	CL = 50 pF	4.3	7.3	4.3	7.3	4.5	7.5	ns	
t <sub>R</sub> t <sub>F</sub>	Output Rise/Fall Time 0.8 V – 2.0 V	All Outputs	CL = 50 pF	-	1.6	-	1.6	ō	1.6	ns	
f <sub>max</sub>	Maximum Input Frequency		CL = 50 pF	135	-	135	-	135	-	MHz	
TW	Minimum Pulse Width Reset			1.5	-	1.5	.E.	1.5	-	ns	
t <sub>rr</sub>	Reset Recovery Time			1.25		1.25	<b>S</b> -	1.25	-	ns	
T <sub>PW</sub>	Pulse Width Out High or Low @ f <sub>in</sub> = 100 MHz and CL = 50 pF	Q0, 1	CL = 50 pF Relative 1.5 V	9.5	10.5	9.5	10.5	9.5	10.5	ns	
Τ <sub>S</sub>	Setup Time SEL to DE, DT			2.0	S IL	2.0	_	2.0	-	ns	
TH	Hold Time SEL to DE, DT		653	2.0	<b>O</b>	2.0	-	2.0	-	ns	

#### Table 6. AC CHARACTERISTICS (V<sub>T</sub> = V<sub>E</sub> = 5.0 V $\pm$ 5%)

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

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